



Product Change Notification

Change Notification #: 114600 - 00
Change Title: Intel® SEROCCO™ PEF20525 Chipset,
Intel® SEROCCO™ PEF20542 Chipset,
Intel® XWAY™ MUNICH512 PEF20512
Chipset, Intel® XWAY™ UTAH Network
Processor,
PCN 114600-00, Product Discontinuance,
End Of Life
Date of Publication: May 12, 2016

Key Characteristics of the Change:
Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	Dec 31, 2016
Last Product Discontinuance Shipment Date:	Jun 30, 2017

Description of Change to the Customer:

Intel is announcing the discontinuance of the products listed within the affected products table within this PCN notice.

Customers should place their Last Time Orders by December 31, 2016 and delivery of all orders must be taken no later than June 30, 2017.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand and place your "Last Product Discontinuance Orders" in accordance with the "Key Milestones" listed above.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#	Stepping
Intel® XWAY™ UTAH Network Processor,	SAFC165HLF	S LLFL	946495	A3
Intel® XWAY™ UTAH Network Processor,	SAFC165UTAHLF	S LLFM	946496	A3
Intel® XWAY™ MUNICH512 PEF20512 Chipset	PEF20512E	S LL6K	946613	A2
Intel® SEROCCO™ PEF20525 Chipset	PEF20525F	S LL6L	946614	A3
Intel® SEROCCO™ PEF20542 Chipset	PEF20542F	S LL6N	946615	A3

PCN Revision History:

Date of Revision:

May 12, 2016

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com
Asia Pacific/PRC Contact: apacgccb@intel.com
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